

WATER-SOLUBLE POLYIMIDE PRECURSOR,
AQUEOUS POLYIMIDE PRECURSOR SOLUTION, POLYIMIDE,
IMPREGNATED MATERIAL WITH POLYIMIDE BINDER, AND LAMINATE

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ABSTRACT OF THE DISCLOSURE

10 A water-soluble polyimide precursor, which can be
suitably applied for aromatic polyimides and exhibits a
low reduction in heat resistance and mechanical
properties, an aqueous solution of the polyimide
precursor and a polyimide obtained from the precursor. A
15 heat-resistant fiber impregnated material and an
impregnated sheet-like material are prepared by using the
precursor and a laminate is prepared by employing the
precursor.

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